

# MX554GBB15M3333

### Ultra-Low Jitter 15.333333MHz LVDS XO

#### ClockWorks® FUSION

## **General Description**

The MX554GBB15M3333 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

### Features

- 15.333333MHz LVDS
- Typical phase noise:
  - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

## Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T <sub>S</sub> ) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

## **Electrical Characteristics**

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100 $\Omega$  between Q and /Q.<sup>3</sup>

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current			90	100	mA
F0	Center Frequency			15.333333		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	v
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	v
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

Notes:

1. Exceeding the absolute maximum ratings may damage the device.

2. The device is not guaranteed to function outside its operating ratings.

3. Guaranteed after thermal equilibrium.

4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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Revision 1.0 tcghelp@microchip.com

# **Operating Ratings<sup>2</sup>**

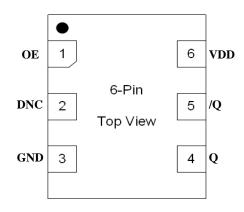
Supply Voltage (VIN)	+2.375V to +3.63V
Ambient Temperature (TA)	40°C to $+85°C$
Junction Thermal Resistance	
LGA (T <sub>IC</sub> ) Still Air	
, jC	

# **Ordering Information**

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554GBB15M3333	MX554G	BB0153	Tube	6-Pin 5mm x 3.2mm LGA
MX554GBB15M3333-TR	MX554G	BB0153	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

# **Pin Configuration**



# **Pin Description**

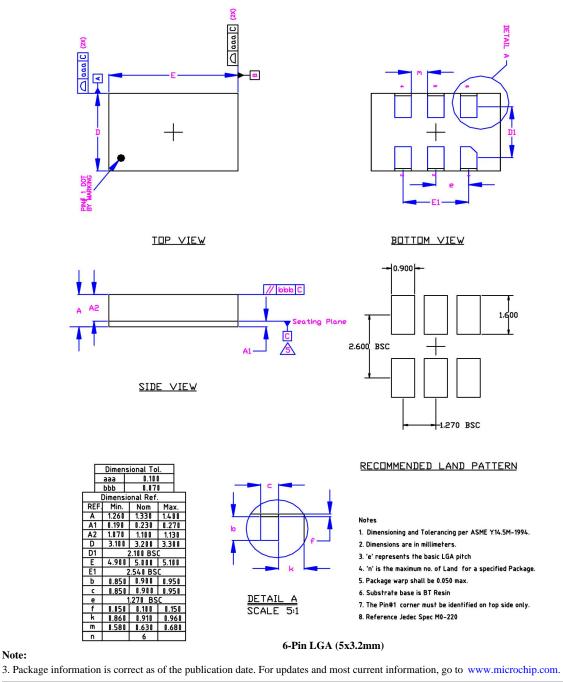
Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k $\Omega$ Pull-Up (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 15.333333MHz
6	VDD	PWR		Power Supply

## **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition C
Mechanical Vibration	MIL-STD-883, Method 2007, Condition B
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
MSL Level	Crystal - MSL-1, Package MSL-3
Solvent Resistance	MIL-STD-202, Method 215
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### Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



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Note: